



3A TRENCH SCHOTTKY BARRIER RECTIFIER SMAF

Product Summary (@ TA = +25°C)

| Ī | V _{RRM} (V) | I ₀ (A) | V _{F(MAX)} (V) | I _{R(MAX)} (mA) |
|---|----------------------|--------------------|-------------------------|--------------------------|
| | 40 | 3 | 0.50 | 0.20 |

Applications

For use in low-voltage, high-frequency inverters, freewheeling, DC-DC converters, and polarity applications.

- SMPS
- AC-DC

Notes:

- DC-DC Converter
- Freewheeling Diodes
- Reverse Polarity Protection
- Blocking Diodes

Features and Benefits

- Low Leakage Current
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SMAF
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish.) Solderable per MIL-STD-202, Method 208 ^(C3)
- Polarity Indicator: Cathode Band
- Weight: 0.036 grams (Approximate)



SMAF



Device Symbol

Ordering Information (Note 4)

| Part Number | Compliance | Package | Packaging |
|-------------|------------|---------|--------------------|
| B340AXF-13 | Commercial | SMAF | 10,000/Tape & Reel |

EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information (Note 5)



DV4 = Product Type Marking Code) || = Manufacturer's Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 1 for 2021) WW = Week Code (01 to 52) XX = Foundry and Assembly Site

Note: 5. Device has a cathode band (as shown) and may also have a cathode notch.



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

| Characteristic | Symbol | Value | Unit |
|---|--------|-------|------|
| Peak Repetitive Reverse Voltage | Vrrm | 40 | |
| Working Peak Reverse Voltage | Vrwm | 40 | V |
| DC Blocking Voltage | Vrm | 40 | |
| Average Rectified Output Current | lo | 3 | А |
| Non-Repetitive Peak Forward Surge Current 1ms Single Half Sine-Wave Superimposed on Rated Load | IFSM | 65 | А |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|----------------------|-------------|------|
| Thermal Resistance, Junction to Ambient (Note 6) | R _{0JA} | 51 | 8CAM |
| Thermal Resistance, Junction to Case (Note 6) | Rejc | 28 | °C/W |
| Operating and Storage Temperature Range | TJ, T _{STG} | -55 to +150 | °C |

Note: 6. Device mounted on FR-4 substrate, 0.4"*0.5", 2oz, single-sided, PC boards with 0.2"*0.25" copper pad. The heat generated must be less than the thermal conductivity from junction to case: dP_D /dT_J < 1/R_{θJC} or junction to ambient: dP_D /dT_J < 1/R_{θJA}.

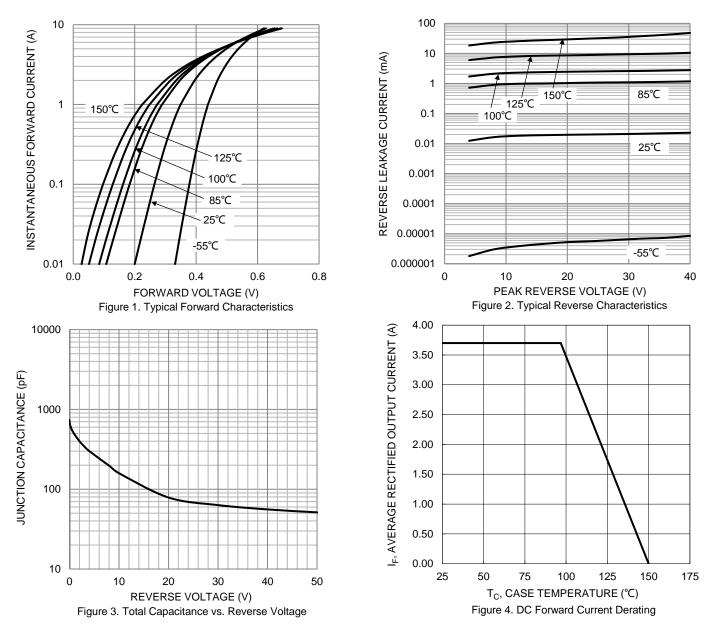
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Тур | Max | Unit | Test Condition |
|--------------------------|--------|------|------|-------------|---|
| Forward Valtage Dran | N | 0.45 | 0.50 | V | IF = 3.0A, TJ = +25°C |
| orward Voltage Drop | VF | 0.39 | — | V IF = 3.04 | IF = 3.0A, TJ = +100°C |
| Leakage Current (Note 7) | | 0.02 | 0.20 | mA | V _R = 40V, T _J = +25°C |
| | IR | 4 | 20 | | V _R = 40V, T _J = +100°C |

Note: 7. Short duration pulse test used to minimize self-heating effect.



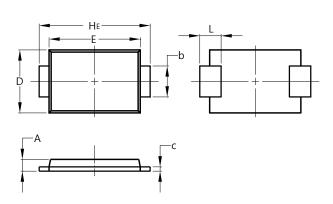
B340AXF





Package Outline Dimensions

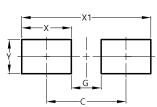
Please see http://www.diodes.com/package-outlines.html for the latest version.



| SMAF | | | | |
|----------------------|------|------|--|--|
| Dim | Min | Max | | |
| Α | 0.90 | 1.10 | | |
| b | 1.25 | 1.65 | | |
| С | 0.10 | 0.40 | | |
| D | 2.25 | 2.95 | | |
| E | 3.95 | 4.60 | | |
| HE | 4.80 | 5.60 | | |
| L | 0.50 | 1.50 | | |
| All Dimensions in mm | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 4.00 |
| G | 1.50 |
| Х | 2.50 |
| X1 | 6.50 |
| Y | 1.70 |

SMAF

SMAF



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